

SIPMOS[®] Small-Signal-Transistor

Feature

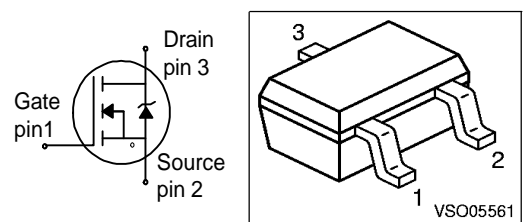
- N-Channel
- Enhancement mode
- Logic Level
- dv/dt rated
- Pb-free lead plating; RoHS compliant
- Qualified according to AEC Q101
- Halogen-free according to IEC61249-2-21



Product Summary

V_{DS}	60	V
$R_{DS(on)}$	5	Ω
I_D	0.23	A

PG-SOT-323



Type	Package	Pb-free	Tape and Reel Information	Marking
SN7002W	PG-SOT-323	Yes	H6327: 3000 pcs/reel	sSN
SN7002W	PG-SOT-323	Yes	H6433: 10000 pcs/reel	sSN

Maximum Ratings, at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Continuous drain current	I_D		A
$T_A=25\text{ }^\circ\text{C}$		0.23	
$T_A=70\text{ }^\circ\text{C}$		0.18	
Pulsed drain current	$I_{D\text{ puls}}$	0.92	
$T_A=25\text{ }^\circ\text{C}$			
Reverse diode dv/dt	dv/dt	6	kV/ μs
$I_S=0.23\text{A}$, $V_{DS}=48\text{V}$, $di/dt=200\text{A}/\mu\text{s}$, $T_{j\text{max}}=150\text{ }^\circ\text{C}$			
Gate source voltage	V_{GS}	± 20	V
ESD class (JEDEC22-A114-HBM)		0 (<250V)	
Power dissipation	P_{tot}	0.5	W
$T_A=25\text{ }^\circ\text{C}$			
Operating and storage temperature	T_j, T_{stg}	-55... +150	$^\circ\text{C}$
IEC climatic category; DIN IEC 68-1		55/150/56	

Thermal Characteristics

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics					
Thermal resistance, junction - ambient at minimal footprint	R_{thJS}	-	-	250	K/W

Electrical Characteristics, at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Drain-source breakdown voltage $V_{GS}=0, I_D=250\mu\text{A}$	$V_{(BR)DSS}$	60	-	-	V
Gate threshold voltage, $V_{GS} = V_{DS}$ $I_D=26\mu\text{A}$	$V_{GS(th)}$	0.8	1.4	1.8	
Zero gate voltage drain current $V_{DS}=60\text{V}, V_{GS}=0, T_j=25^\circ\text{C}$ $V_{DS}=60\text{V}, V_{GS}=0, T_j=150^\circ\text{C}$	I_{DSS}	-	-	0.1 5	μA
Gate-source leakage current $V_{GS}=20\text{V}, V_{DS}=0$	I_{GSS}	-	-	10	nA
Drain-source on-state resistance $V_{GS}=4.5\text{V}, I_D=0.2\text{A}$	$R_{DS(on)}$	-	4.1	7.5	Ω
Drain-source on-state resistance $V_{GS}=10\text{V}, I_D=0.23\text{A}$	$R_{DS(on)}$	-	2.3	5	

Electrical Characteristics, at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	

Dynamic Characteristics

Transconductance	g_{fs}	$V_{DS} \geq 2 \cdot I_D \cdot R_{DS(on)max}$, $I_D = 0.18\text{A}$	0.1	0.21	-	S
Input capacitance	C_{iss}	$V_{GS} = 0$, $V_{DS} = 25\text{V}$, $f = 1\text{MHz}$	-	34	45	pF
Output capacitance	C_{oss}		-	7.2	9.6	
Reverse transfer capacitance	C_{rss}		-	3	4.5	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 30\text{V}$, $V_{GS} = 10\text{V}$, $I_D = 0.23\text{A}$, $R_G = 6\Omega$	-	2.4	3.6	ns
Rise time	t_r		-	2.8	4.2	
Turn-off delay time	$t_{d(off)}$		-	6	9	
Fall time	t_f		-	8.5	12.75	

Gate Charge Characteristics

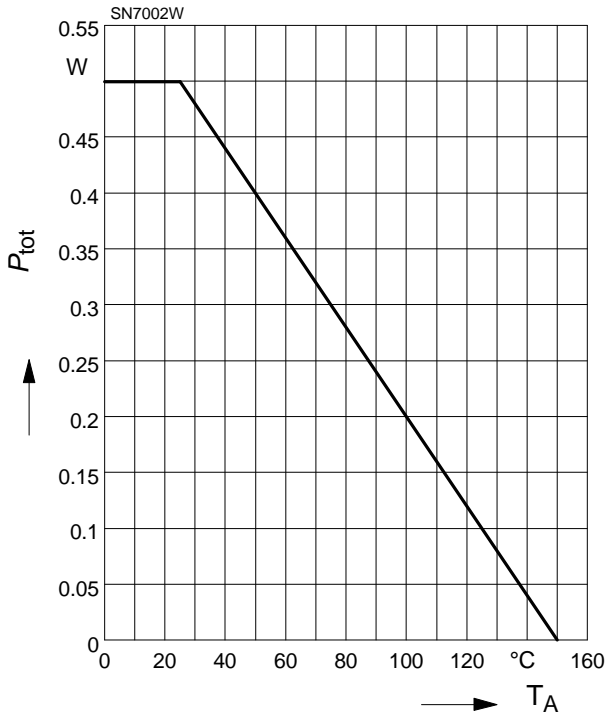
Gate to source charge	Q_{gs}	$V_{DD} = 48\text{V}$, $I_D = 0.23\text{A}$	-	0.11	0.17	nC
Gate to drain charge	Q_{gd}		-	0.42	0.63	
Gate charge total	Q_g	$V_{DD} = 48\text{V}$, $I_D = 0.23\text{A}$, $V_{GS} = 0$ to 10V	-	1	1.5	
Gate plateau voltage	$V_{(plateau)}$	$V_{DD} = 48\text{V}$, $I_D = 0.23\text{A}$	-	3.4	-	V

Reverse Diode

Inverse diode continuous forward current	I_S	$T_A = 25^\circ\text{C}$	-	-	0.23	A
Inv. diode direct current, pulsed	I_{SM}		-	-	0.92	
Inverse diode forward voltage	V_{SD}	$V_{GS} = 0$, $I_F = 0.23\text{A}$	-	0.85	1.2	V
Reverse recovery time	t_{rr}	$V_R = 30\text{V}$, $I_F = I_S$, $di_F/dt = 100\text{A}/\mu\text{s}$	-	10.8	16.2	ns
Reverse recovery charge	Q_{rr}		-	3.2	4.8	

1 Power dissipation

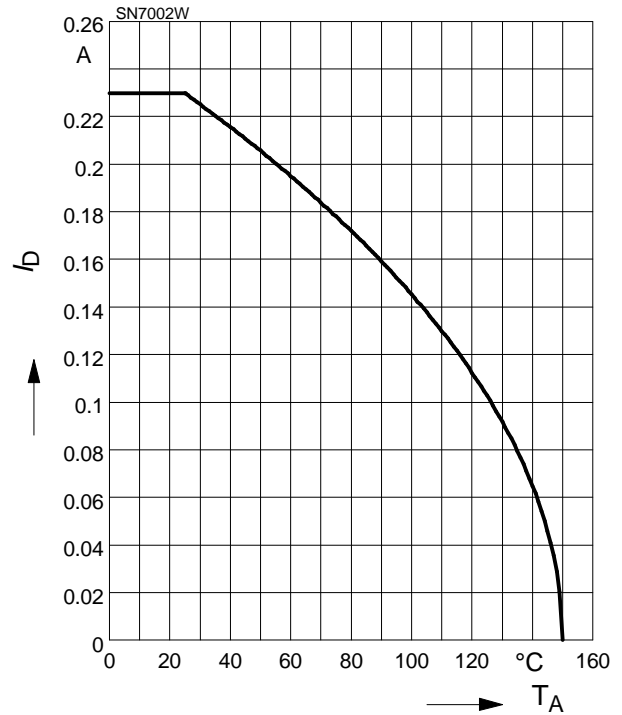
$$P_{tot} = f(T_A)$$



2 Drain current

$$I_D = f(T_A)$$

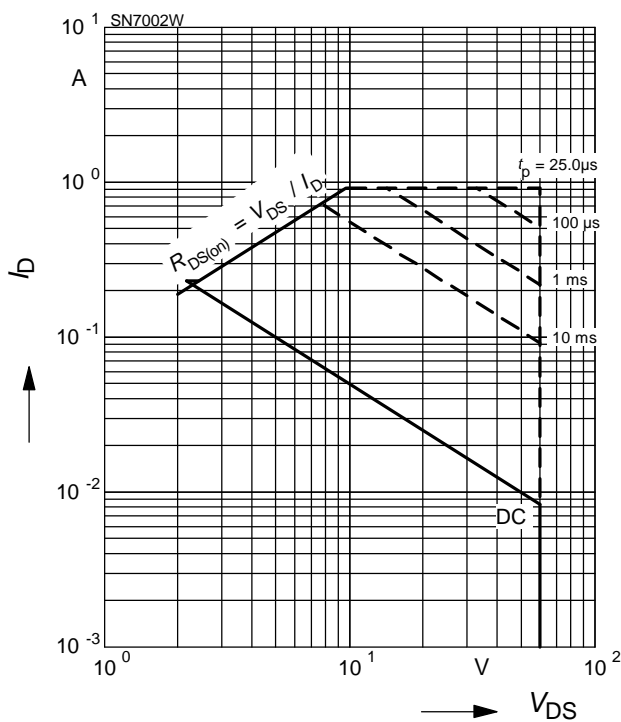
parameter: $V_{GS} \geq 10\text{ V}$



3 Safe operating area

$$I_D = f(V_{DS})$$

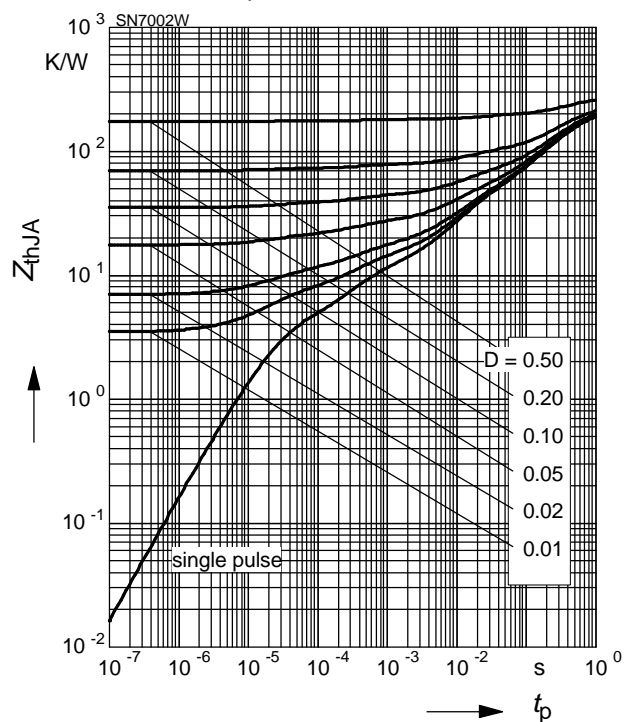
parameter: $D = 0$, $T_A = 25\text{ °C}$



4 Transient thermal impedance

$$Z_{thJA} = f(t_p)$$

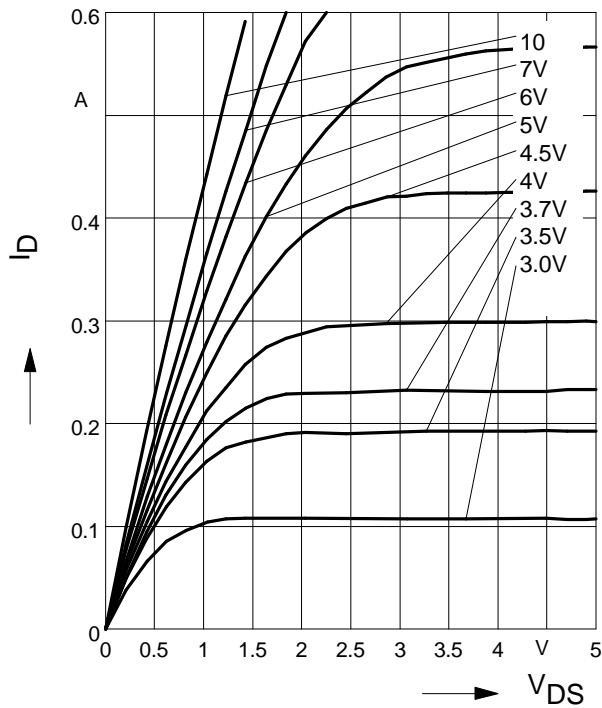
parameter: $D = t_p/T$



5 Typ. output characteristic

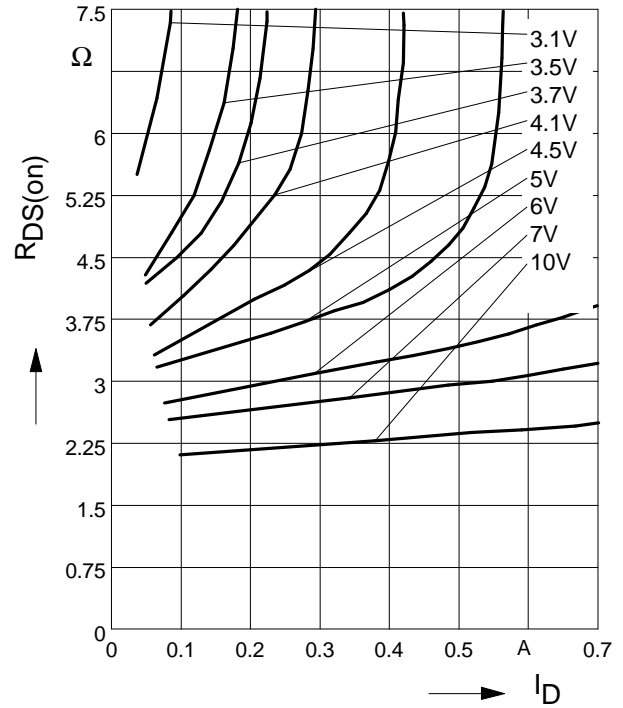
$$I_D = f(V_{DS})$$

parameter: $T_j = 25\text{ }^\circ\text{C}$, V_{GS}


6 Typ. drain-source on resistance

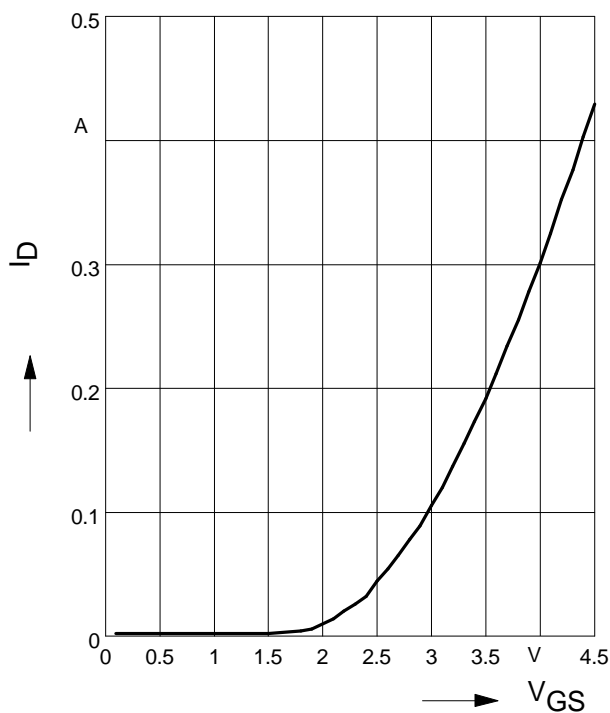
$$R_{DS(on)} = f(I_D)$$

parameter: $T_j = 25\text{ }^\circ\text{C}$, V_{GS}


7 Typ. transfer characteristics

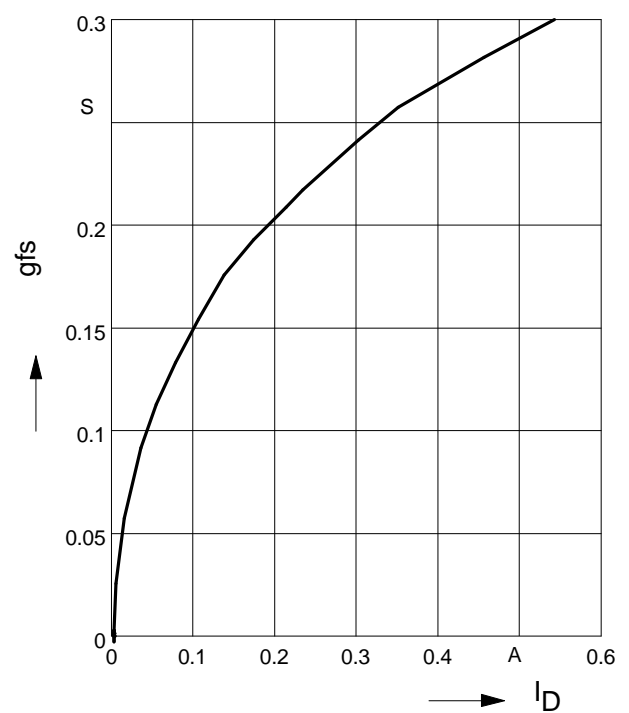
$$I_D = f(V_{GS}); V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$

parameter: $T_j = 25\text{ }^\circ\text{C}$


8 Typ. forward transconductance

$$g_{fs} = f(I_D)$$

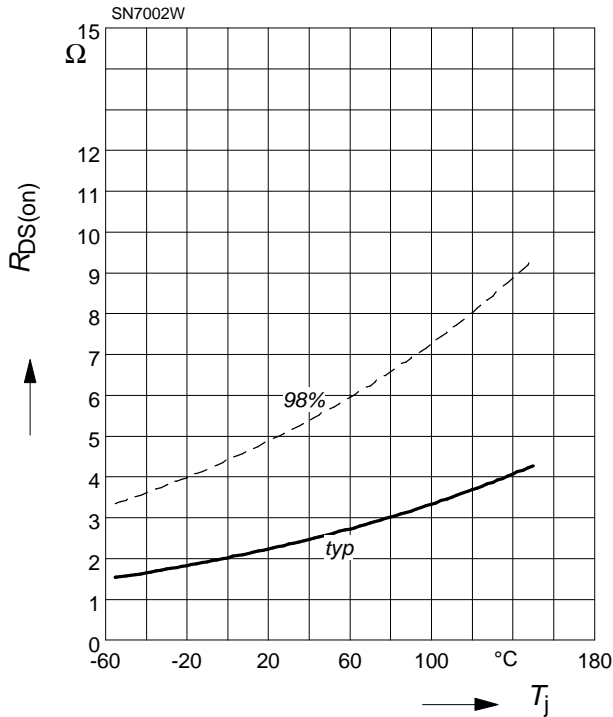
parameter: $T_j = 25\text{ }^\circ\text{C}$



(.) Drain-source on-state resistance

$$R_{DS(on)} = f(T_j)$$

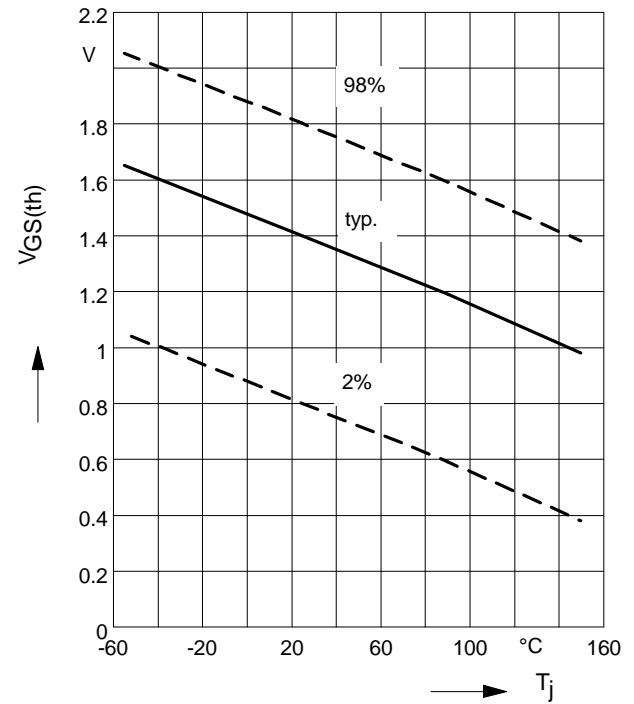
parameter : $I_D = 0.23 \text{ A}$, $V_{GS} = 10 \text{ V}$



10 Typ. gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

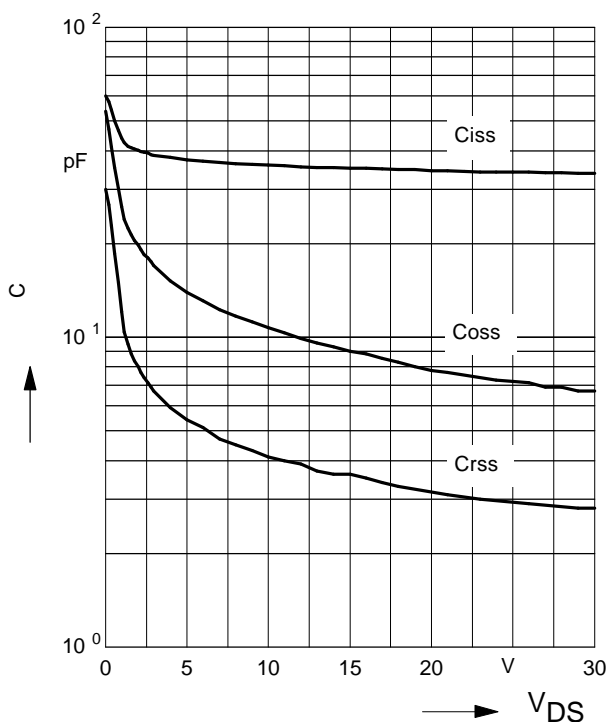
parameter: $V_{GS} = V_{DS}$; $I_D = 26\mu\text{A}$



11 Typ. capacitances

$$C = f(V_{DS})$$

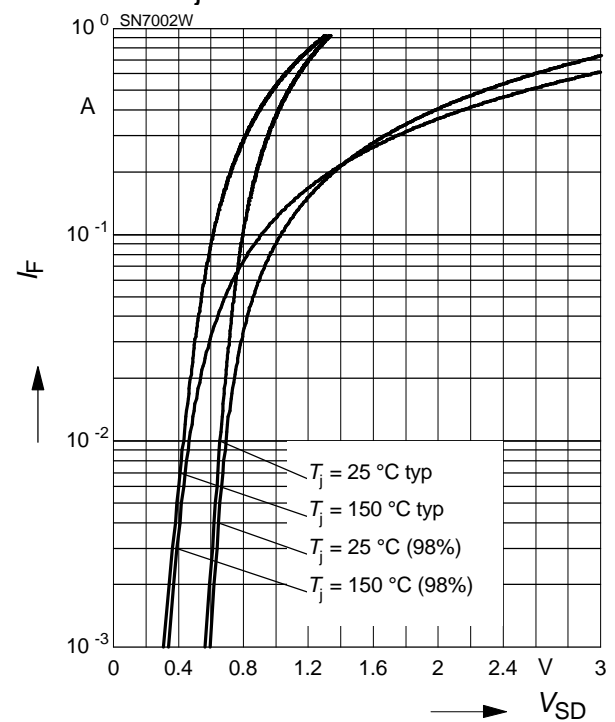
parameter: $V_{GS}=0$, $f=1 \text{ MHz}$, $T_j = 25 \text{ }^\circ\text{C}$



12 Forward character. of reverse diode

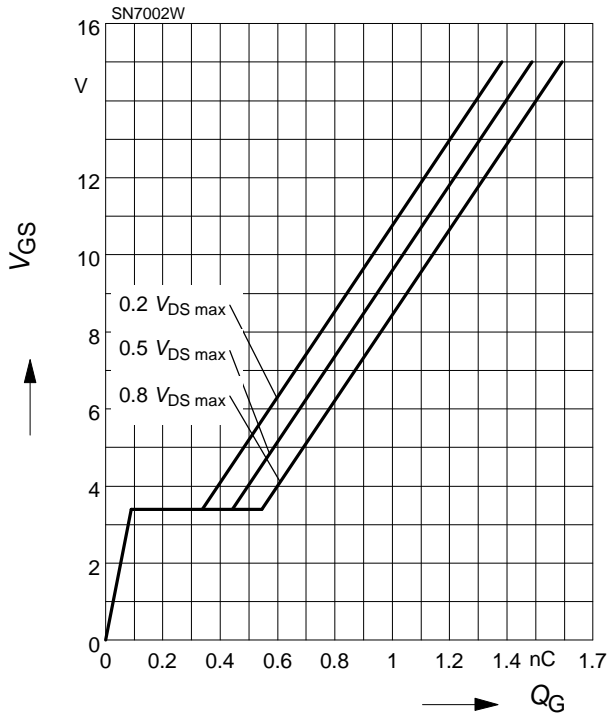
$$I_F = f(V_{SD})$$

parameter: T_j



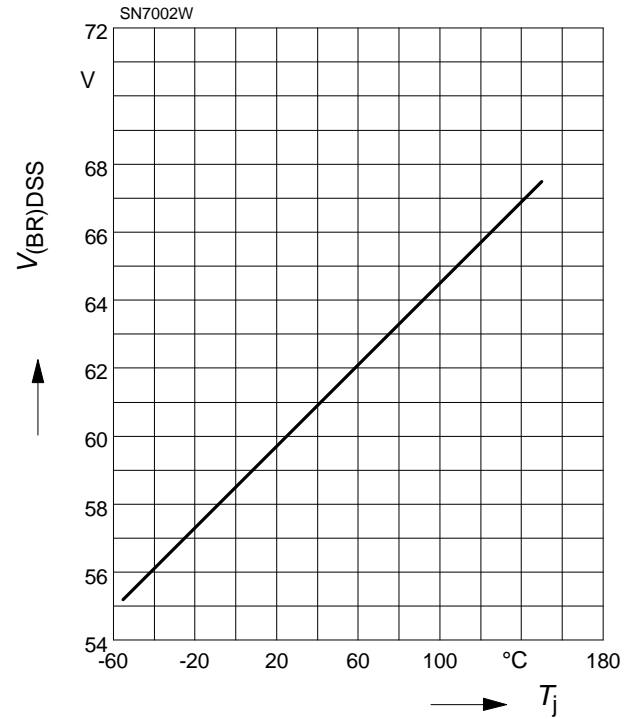
13 Typ. gate charge

$V_{GS} = f(Q_G)$; parameter: V_{DS} ,
 $I_D = 0.16 \text{ A pulsed}$, $T_j = 25 \text{ }^\circ\text{C}$



14 Drain-source breakdown voltage

$V_{(BR)DSS} = f(T_j)$



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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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